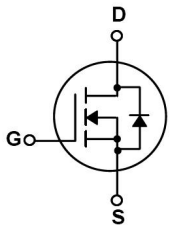
/ Descriptions

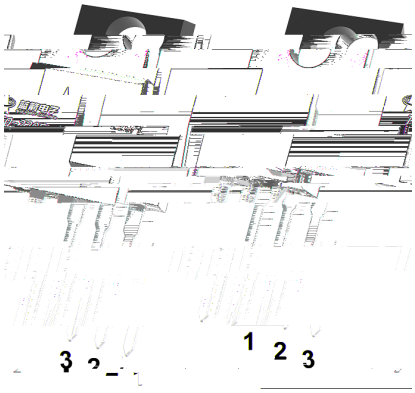
/ Features

/ Applications

/ Equivalent Circuit



/ Pinning

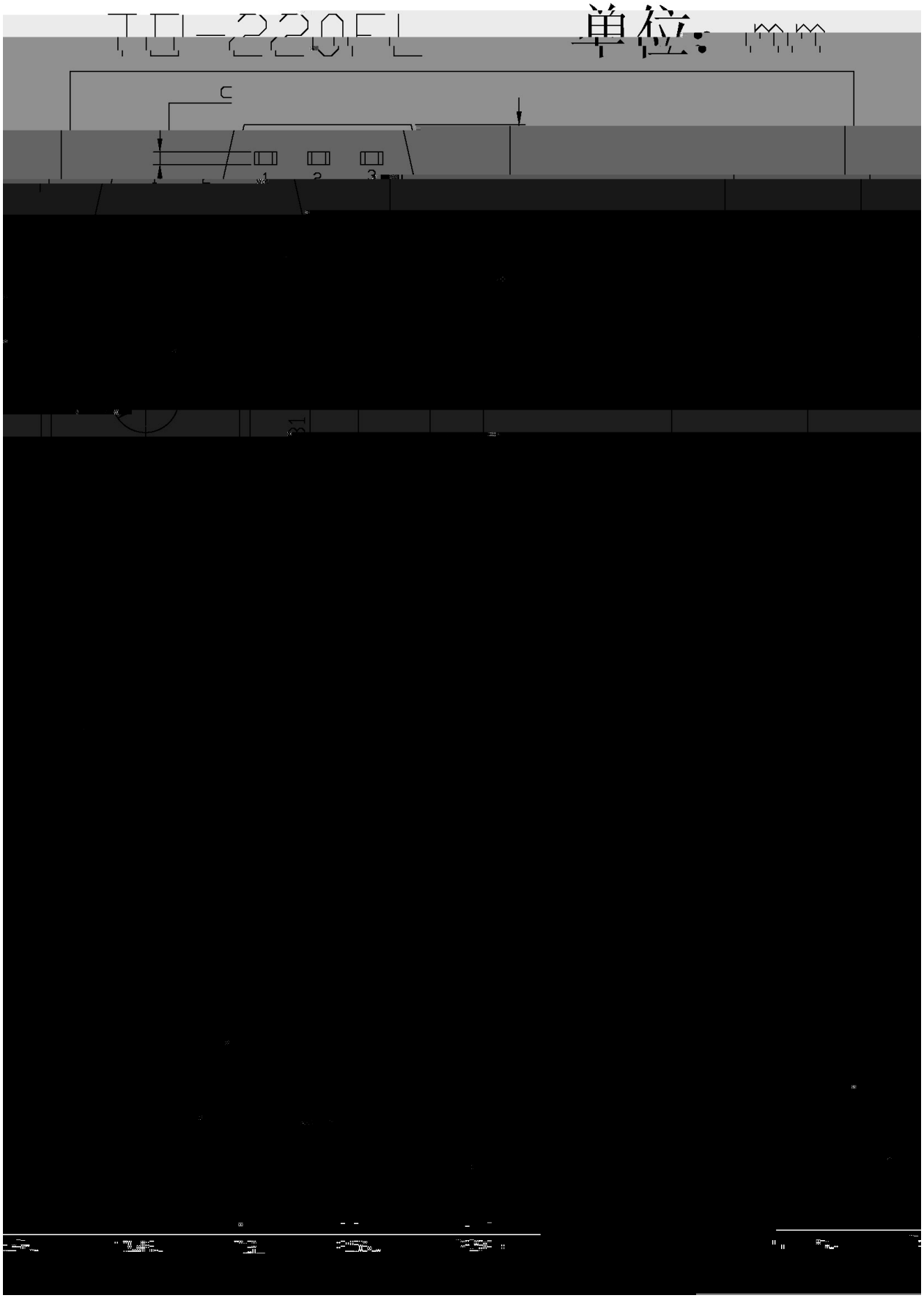


/ Marking

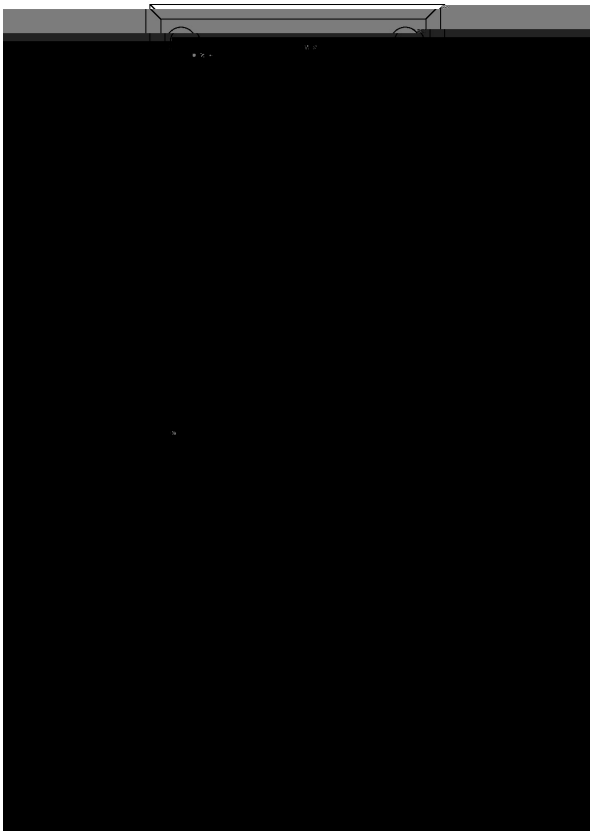
BRFL25N50

DATA SHEET

/ Package Dimensions



/ Marking Instructions



( ) / Temperature Profile for Dip Soldering(Pb-Free)

/ Resistance to Soldering Heat Test Conditions

/ Packaging SPEC.

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